

E band MMIC Dual Low Noise Amplifier

E-DLNA-7590

Previously named CO-E1320304

Dual Circuit GaAs PHEMT MMIC Low Noise Amplifier 75-90GHz

Overview

E-DLNA-7590 is a MMIC combining two 4-stage MMIC low noise amplifiers that cover frequencies from 75GHz to 90GHz band. This MMIC provides two channels with up to 20dB of stable gain, and noise figures of 4.5dB from a 2.5V supply voltage and 30mA current per amplifier. With less than ± 2 dB variation in gain across the band, this LNA provides a low noise solution for both radar and communication applications.

All bond pads and the backside of the MMIC are gold plated. The MMIC is compatible with precision die attach methods, as well as thermo-compression and thermosonic wire bonding, making it ideal for MCM and hybrid microcircuit applications. All data shown is measured with the chip in a 50 Ohm environment, with 100pF decoupling capacitors on all DC connections and is contacted using RF probes.

Available as a single circuit LNA option as part number E-LNA-7590 (previously named CO-E1320303).

Features

- 75 – 90GHz.
- 2 x 20dB gain.
- 4.5dB noise figure.
- Unconditionally stable.
- $< \pm 2$ dB gain variation.

Applications

- Millimeter-wave imaging.
- High resolution radar.
- Sensing.
- P2P communications; short haul/ high capacity/low interference links.
- Medical.
- Automotive radar.

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Specification Overview

Single channel reference

Parameter	Min.	Typ.	Max.	Units
Frequency	75		90	GHz
Gain	17.5	18.5	20.5	dB
Gain Flatness		±2		dB
Input Return Loss		10		dB
Output Return Loss		12		dB
Noise Figure*		4.5		dB
Drain Voltage		2.5		V
Current**		30		mA

Notes

The tests indicated have all been performed with 100pF de-coupling capacitors on all bias pads.

All tests are carried out at 25°C.

*Measured over the 76-82GHz band.

**Gate voltage is set to draw the correct drain current.

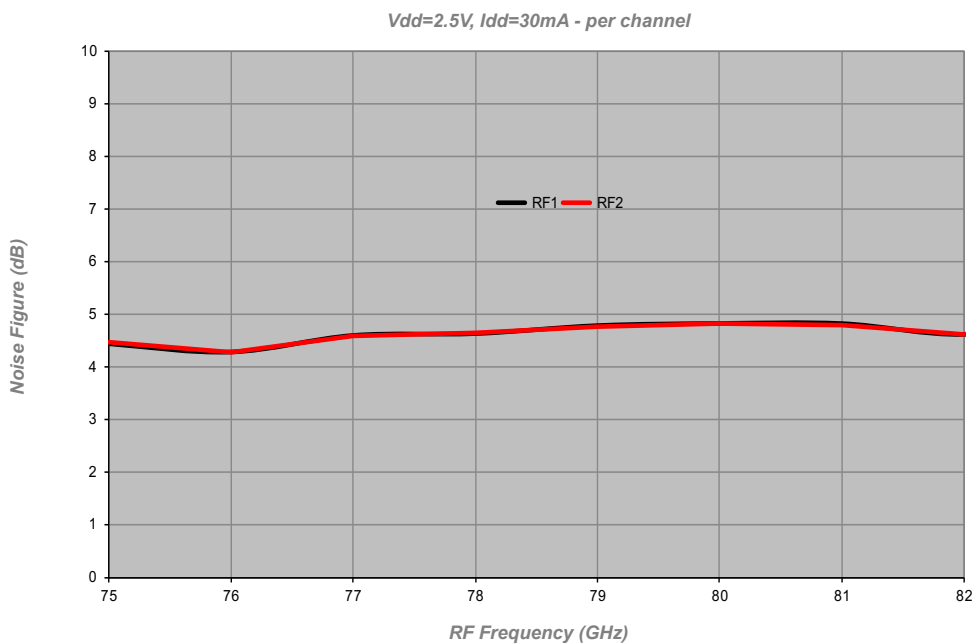
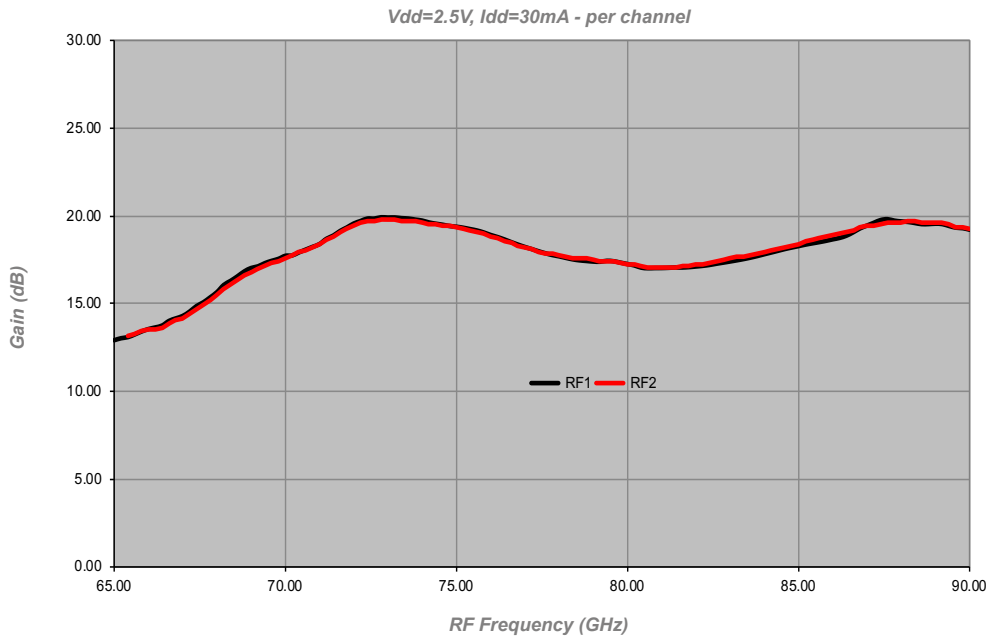
Absolute Maximum Ratings

Parameter	Rating
Gate Voltage	-5V to 0.2V
Drain Voltage	3.5V
Drain Current	40mA
RF Input Power	-5dBm
Storage Temperature	-65°C to +150°C
Channel Temperature	+150°C
Operating Temperature	-40°C to +85°C



ESD (electrostatic discharge) sensitive device. Charged devices and circuit boards can discharge without detection. Although this product features proprietary protection circuitry, damage may occur on devices subjected to ESD. Proper ESD precautions should be taken to avoid performance degradation or loss of functionality.

Measured Performance Data



Measured Performance Data

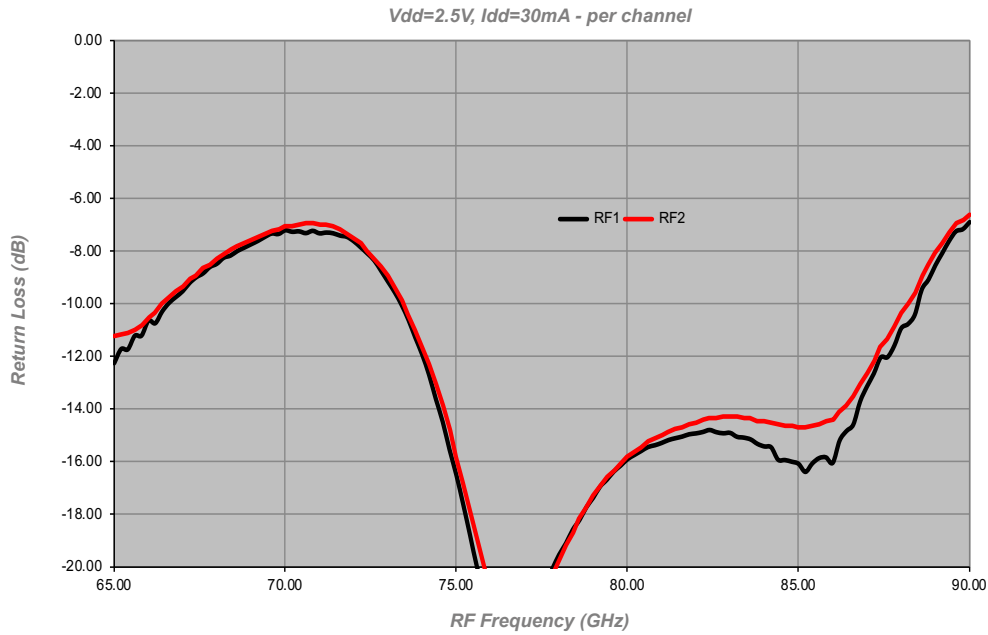


Figure 3
Input Return Loss

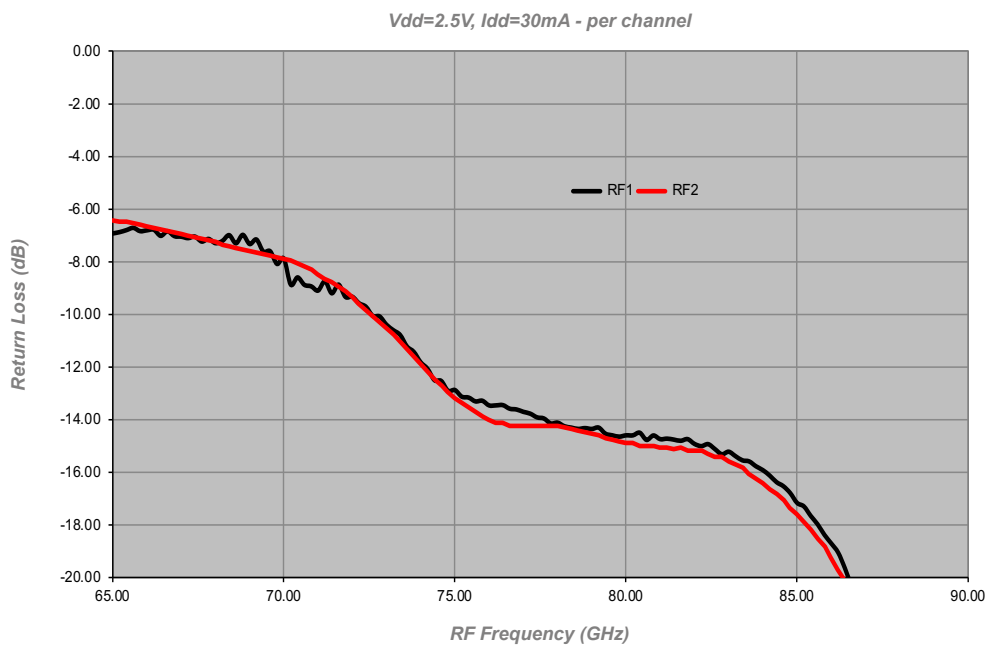


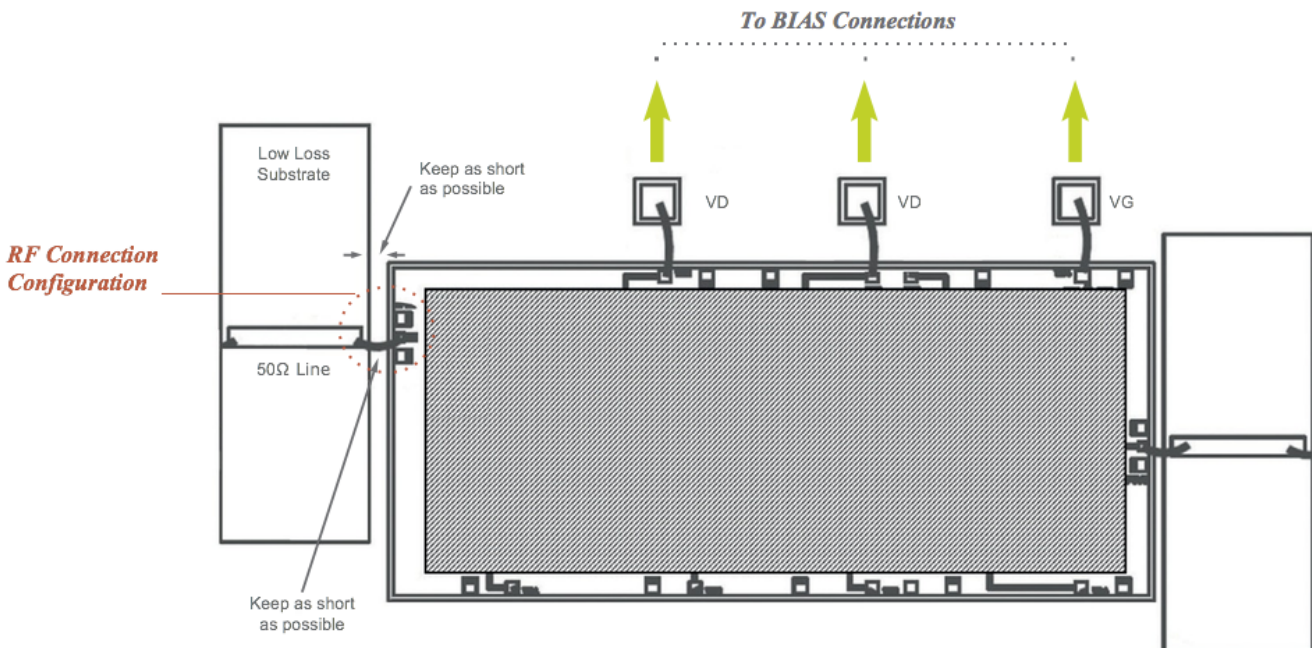
Figure 4
Output Return Loss

Pad Descriptions

Name	Description
RFIN	Input RF pad. This pad is ac coupled.
RFOUT	Output RF pad. This pad is ac coupled.
VD1	Drain bias pad for stage 1.
VD24	Drain bias pad for stages 2, 3 & 4.
VG1	Gate bias pad for stage 1.
VG24	Gate bias pad for stages 2, 3 & 4.
BOTTOM	The die backside must be connected to RF/dc ground.

Connection Configurations

(Not actual die – these rules are applied to all MMICs unless otherwise stated)



General Notes on Assembly

Die should be mounted on conductive material such as gold-plated metal to provide a good ground and suitable heat sink, if necessary.

1. Attaching the die using Au/Sn preforms is preferable. The Eutectic melt for Au/Sn occurs at approximately 280°C so the die (plus mount and preform) is initially heated up to 180°C and then it is heated for approximately 10 seconds to 280°C using a nitrogen heat gun. The device will survive 10 seconds at this temperature. The static breakdown for GaAs devices is approximately 330°C.
2. Pure, dry nitrogen should be used as the heat source.
3. If the devices cannot be lifted/ placed by a vacuum device, then ESD die-lifting tweezers are preferable.
4. Supply lines should be decoupled with 100pF capacitors. Larger planar capacitors could be used if available.
5. Aluminium wire must not be used.

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